LNP™ THERMOCOMP™ COMPOUND MB006SXP

MB-1006 HS-S

DESCRIPTION

LNP THERMOCOMP MB006SXP is a compound based on Polypropylene resin containing Glass Bead. Added featurs include: Heat Stabilized.

TYPICAL PROPERTY VALUES

Revision 20191213

PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
MECHANICAL			
Tensile Stress, yield, 50 mm/min	25	MPa	ISO 527
Tensile Strain, yield, 50 mm/min	7.1	%	ISO 527
Tensile Modulus, 1 mm/min	1900	MPa	ISO 527
Flexural Stress, yield, 2 mm/min	36	MPa	ISO 178
Flexural Modulus, 2 mm/min	1700	MPa	ISO 178
IMPACT			
Izod Impact, unnotched 80*10*4 +23°C	20	kJ/m²	ISO 180/1U
Izod Impact, notched 80*10*4 +23°C	4	kJ/m²	ISO 180/1A
THERMAL			
CTE, 23°C to 60°C, flow	1.07E-04	1/°C	ISO 11359-2
CTE, 23°C to 60°C, xflow	1.2E-04	1/°C	ISO 11359-2
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	62	°C	ISO 75/Af
PHYSICAL			
Mold Shrinkage, flow	1.2 – 1.6	%	SABIC method
Density	1.12	g/cm³	ISO 1183
INJECTION MOLDING			
Drying Temperature	80	°C	
Drying Time	4	hrs	
Melt Temperature	225 – 250	°C	
Front - Zone 3 Temperature	240 – 250	°C	
Middle - Zone 2 Temperature	215 – 225	°C	
Rear - Zone 1 Temperature	195 – 205	°C	
Mold Temperature	30 – 50	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

DISCLAIMER